



ThinFlex



ThinFlex Corporation

No. 8, Luke 2nd.Rd., Luzhu Dist., Kaohsiung City, 821, Taiwan, R.O.C. (Kaohsiung Science Park) Tel: +886-7-6955236 Fax: +886-7-6955539 http://www.thinflex.com.tw e-mail: service@thinflex.com.tw

ThinFlex W-1005ED-N4 Adhesiveless Double Sided Copper Clad Laminate (Halogen Free)

IPC Designation IPC-4204/11

ThinFlex W-1005ED-N4 is an adhesiveless double-sided (D/S) copper clad laminate, using ThinFlex TPI film and laminated with ED copper foil on both sides. ThinFlex W-1005ED-N4 adhesiveless D/S composites are designed for a wide variety of flexible circuit applications which require advanced material performance, temperature resistance, fine pitch, and high reliability.

1. Product Characteristics:

- * Excellent dimensional stability
- * Excellent flexibility
- * Finer line etching capability
- * Low moisture absorption
- * Excellent flammability
- * Excellent chemical resistance
- * Excellent thermal, mechanical, and electrical properties

2. Specifications:

W- 10 05 E D-N4

Product W : D/S FCCL	Thickness of PI 10 : 1.0 mil	Thickness of Cu 05 : 1/2 oz	Cu Type E : ED	Structure Double-sided
Supply Size	W: 250/500 ± 1mm; L: 400~700 ± 2mm (sheet type) W: 250/500 ± 1mm; L: 100 +2/-0m (roll type)			

*Other thicknesses and dimensions are available on customers' demand.



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3. Construction:

Copper foil
Polyimide film
Copper foil

4. Properties:

IPC Designation IPC-4204/11

Test item	Unit	W-1005ED-N4	Test Method	
Peel Strength				
As Received	Kgf/cm	≥0.8	IPC-TM650 2.4.9 B	
Solder Float	Kgf/cm	≥0.8	IPC-TM650 2.4.13 B	
After Temp. Cycling	Kgf/cm	≥0.8	IPC-TM650 2.4.9	
Chemical Resistance	Kgf/cm	≥0.8	IPC-TM650 2.3.2	
Tensile Strength (Base Film)	Kg/mm ²	33	IPC-TM-650 2.4.19	
Elongation (Base Film)	%	42	IPC-TM-650 2.4.19	
Tensile Modulus (Base Film)	Kg/mm ²	500	ASTM D882	
Initial Tear Strength (Base Film)	g	720	IPC-TM-650 2.4.16	
Propagation Tear Strength (Base Film)	g	15	IPC-TM-650 2.4.17.1	
Flexural Endurance, MIT				
M.D.	Cycles	≥600	JIS-C 6471, 0.8mmR, 0.5kg	
T.D.	Cycles	≥600	JIS-C 6471, 0.8mmR, 0.5kg	
Electrical Properties				
Surface Resistance	Ω	≥1.0×10 ¹¹	IPC-TM650 2.5.17	
Volume Resistance	Ω-cm	≥1.0×10 ¹²	IPC-TM650 2.5.17	
Insulation Resistance	Ω	≥1.0×10 ⁹	IPC-TM650 2.6.3.2	
Dielectric Strength	kV/mil	5.5	ASTM-D149	
Dielectric Constant	-	3.3	IPC-TM650 2.5.5.3	
Dissipation factor	-	0.01	IPC-TM650 2.5.5.3	
Physical and Thermal Properties				
Dimensional Stability	M.D.	%	-0.1~-0.1	IPC-TM650 2.2.4C
	T.D.	%	-0.1~-0.1	IPC-TM650 2.2.4C
CTE	ppm/°C	24	ThinFlex	
T _g	°C	350	ThinFlex	
Solder Float	30sec at 288°C (550°F)	-	Pass	IPC-TM650 2.4.13
Moisture Absorption Test	%	1.1	IPC-TM650 2.6.2	
Chemical Resistance-single	-	Pass	IPC-TM650 2.3.2	
Thickness tolerance	μm	61±10%	ThinFlex	
UL Flame Class	-	94V-0	UL	

* Above data are typical values, and are not guaranteed values.



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5. Storage:

ThinFlex-W-1005ED-N4 will meet its shelf-life for at least 12 months after arrival at the user's factory when stored in the original packaging at temperatures of below 25°C and below 70% humidity. The products do not need refrigeration and should not be frozen.

Note: The information and data contained in this technical literature is believed to be accurate and is offered in good faith for the benefit of the user. The user should make his own tests to verify the suitability of this product for any application before its use. All data are typical values only and subject to change without notice.

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